

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

Voltage: 800 Volts

Current: 7 Ampers

Package: TO-263

Features

- NH'S Advanced Planar DMOS Technology
- Low Rds(on) For Low On-State Loss
- High EAS For High Reliability
- Qualified According To JEDEC Criteria

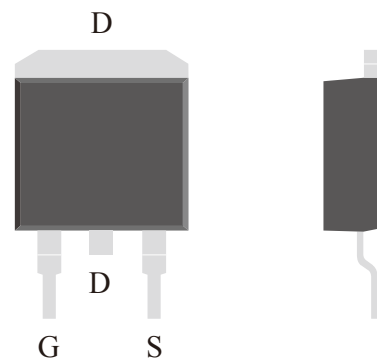
Typical Applications

- AC/DC Converter
- Adaptor And Charger
- PC Power
- LED Drives And LED Lighting

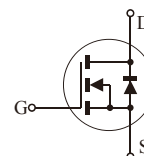
Product Summary

VDS Min.@Tj	800	V
ID Min.@Ta	7	A
RDS(ON)(TYP)@10V	1.25	Ω

Diagram:



Polarity:



***100% UIS TESTED**

***100% ΔVDS TESTED**

Absolute Maximum Ratings (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Ratings	Unit
Drain-Source Voltage		V _{DS}	800	V
Gate-Source Voltage		V _{GS}	±30	V
Continuous Drain Current (Note 1)	Ta= 25 ℃	I _D	7	A
	Ta= 100 ℃		4	
Drain Current-Pulse (Note 1)	Tj< 150 ℃	I _{DM}	28	A
Maximum Power Dissipation Power Dissipation Derating Factor Above 25℃	Ta= 25 ℃	P _D	133	W
	Ta= 100 ℃		53	
Derating Factor		D _F	1.06	W/℃
Avalanche Current,Single Pulse (Note 1)	L= 10.0 mH	I _{AS}	8	A
Single Pulse Avalanche Energy (Note 1) Test Circuit & Waveform See Fig.17	L= 10.0 mH IAS= 8 A, RG= 10.0 Ω Starting Tj=25 ℃, VG = 10.0 V	E _{AS}	320	mJ

Thermal Characteristics (Ta=25℃ Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Typ.	Unit
Junction Temperature		T _J	-55 to 150	℃
Storage Temperature Range		T _{STD}	-55 to 150	℃
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	R _{θJA}	62.5	℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	0.94	

Notes: 1.Pulse Width Limited By Max. Junction Temperature. (See Fig. 14).

NPS7N80D

N-Channel Enhancement Mode Power MOSFET
Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Static Off Characteristics						
Drain-Source Breakdown Voltage	VGS=0V,ID=250uA	BV _{DSS}	800	--	--	V
Bvdss Temperature Coefficient	ID=250uA,Reference25℃	ΔBV _{DSS} /ΔT _J	--	0.95	--	V/℃
Drain-Source Leakage Current	VDS= 800 V,VGS=0V	I _{DSS}	--	--	1	uA
Gate-Body Leakage Current	VGS= ±30 V,VDS=0V	I _{GSS}	--	--	±100	nA
Forward Transconductance	ID= 3.5 A,VDS= 15 V	g _{fs}	--	9	--	S
Static On Characteristics						
Gate Threshold Voltage	VGS= VDS ID=250uA	V _{GS(TH)}	2	3	4	V
Drain-Source On Resistance	ID= 3.5 A,VGS= 10.0 V	R _{DS(ON)}	--	1.25	1.4	Ω
	ID= 3.5 A,VGS= 5.0 V		--	1.81	2.1	
Dynamic Characteristics						
Gate Resistance	VGS=0V,VDS=0V, Freq.=1MHz	R _g	--	0.6	--	Ω
Input Capacitance	VDS= 50 V	C _{iss}	--	1626	--	pF
Output Capacitance	VGS= 0 V	C _{oss}	--	87	--	pF
Reverse Transfer Capacitance	F= 1 MHZ	C _{rss}	--	9	--	pF
Switching Paramters (Test Circuit & Waveform See Fig.15)						
Turn-On Delay Time	VDS= 50 V	t _{d(on)}	--	21	--	ns
Turn-On Rise Time	VGS= 10.0 V	t _r	--	18	--	ns
Turn-Off Delay Time	RG= 10.0 Ω	t _{d(off)}	--	50	--	ns
Turn-Off Rise Time	L= 10.0 mH	t _f	--	21	--	ns
Gate Charge Paramters (Test Circuit & Waveform See Fig.16)						
Total Gate Charge	VDS= 50 V	Q _g	--	34	--	nC
Gate-Source Charge	VGS= 10.0 V	Q _{gs}	--	7	--	nC
Gate-Drain Charge	ID= 7.0 A	Q _{gd}	--	16	--	nC
Drain-Source Diode Characteristics And Maximum Ratings (Test Circuit & Waveform See Fig.18)						
Max. Diode Forward Cuurent		I _S	--	--	7.0	A
Max. Pulsed Forward Cuurent		I _{SM}	--	--	28	A
Diode Forward Voltage	ID= 3.5 A,VGS=0V	V _{SD}	--	0.8	1.5	V
Reverse Recovery Time	IS= 3.5 A,di/dt= 100 A/us	t _{rr}	--	630	--	ns
Reverse Recovery Charge	VGS= 0.0 V	Q _{rr}	--	5000	--	nC
Reverse Recovery Current		I _{RRM}	--	16.0	--	A

NPS7N80D

N-Channel Enhancement Mode Power MOSFET



Typical Characteristics Curves

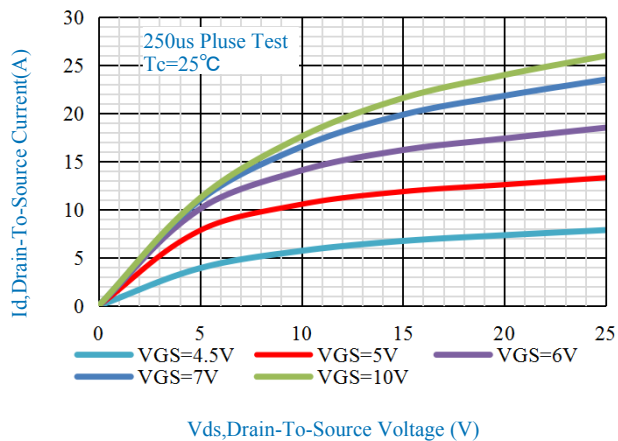


Fig.1-Output Characteristics

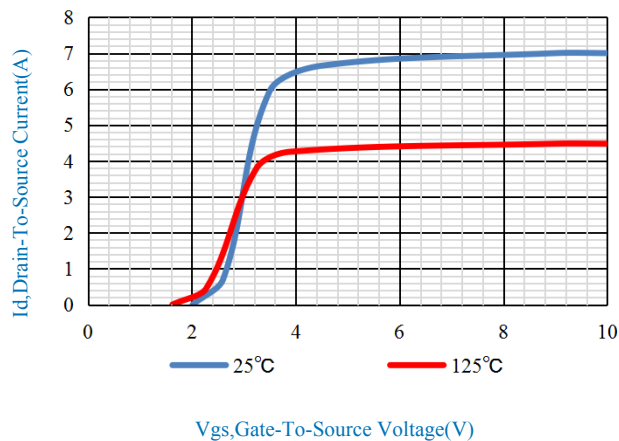


Fig.2-Transfer Characteristics

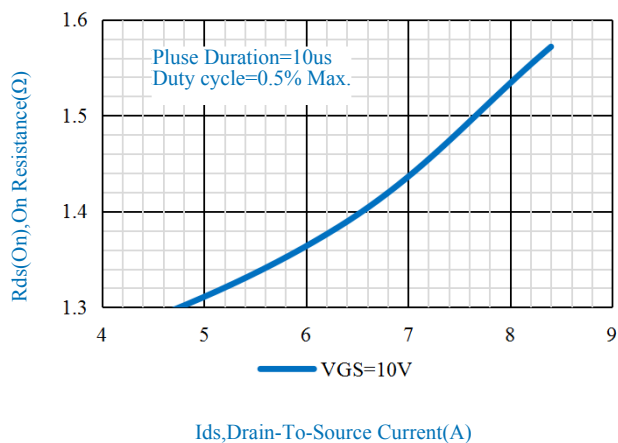


Fig.3-On Resistance Vs. Drain Current

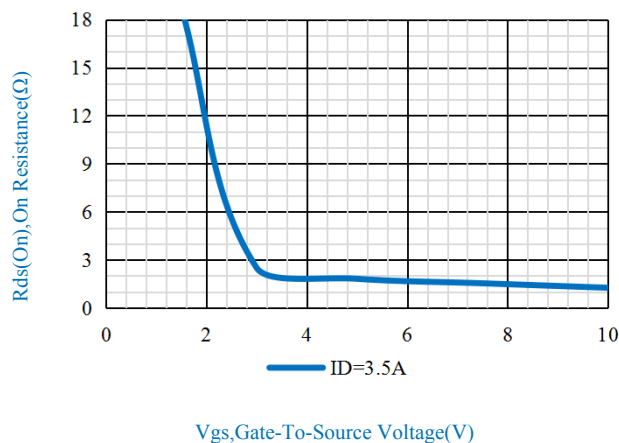


Fig.4-On Resistance Vs. Gate Source Voltage

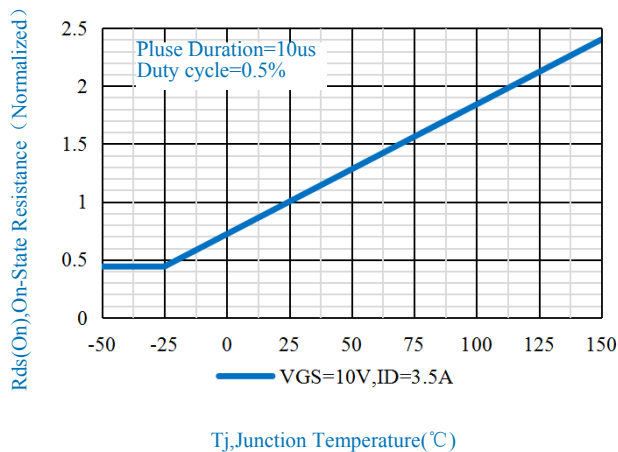


Fig.5-On Resistance Vs. Junction Temperature

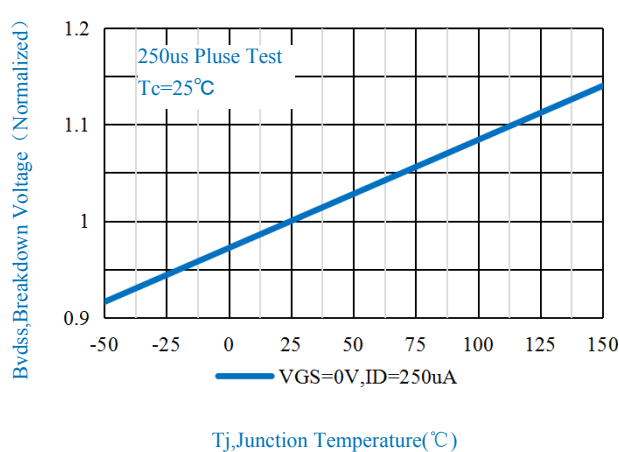


Fig.6-Breakdown Voltage Vs. Junction Temperature

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

Typical Characteristics Curves

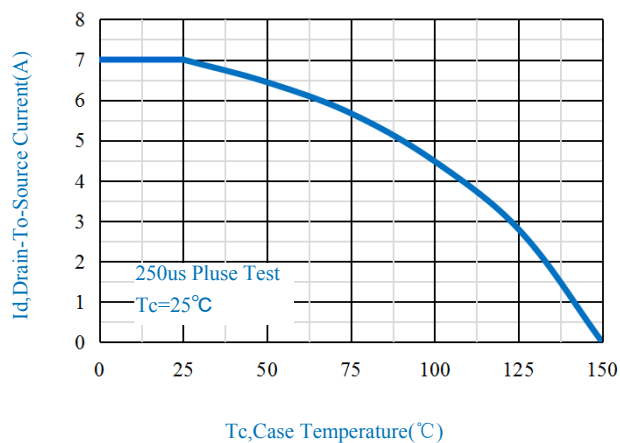


Fig.7-Maximum Continuous Drain Current Vs. Case Temperature

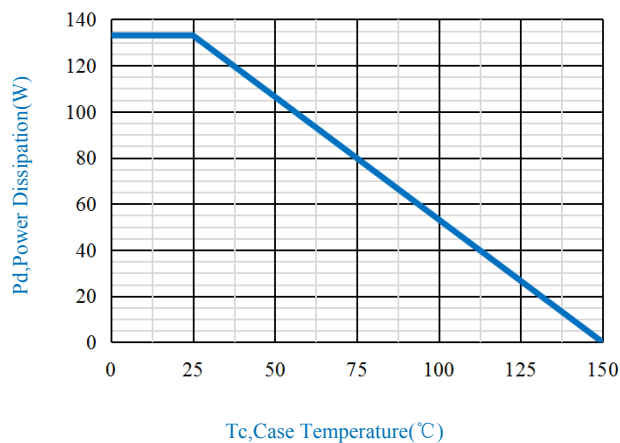


Fig.8-Maximum Power Dissipation Vs. Case Temperature

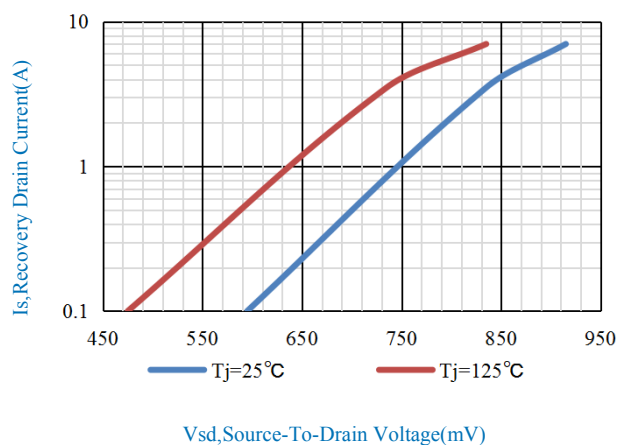


Fig.9-Source-To-Drain Diode Forward Voltage

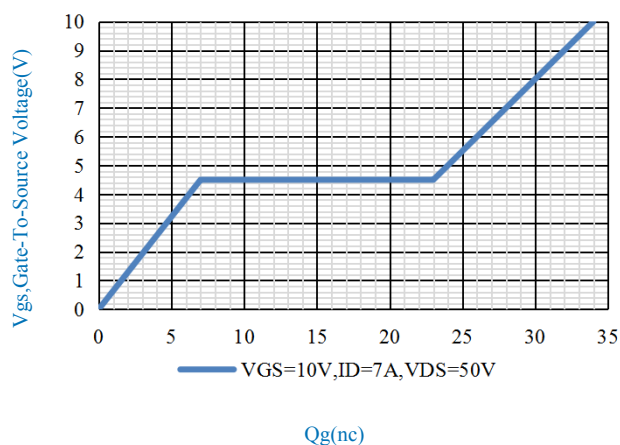


Fig.10-Gate Charge Waveform

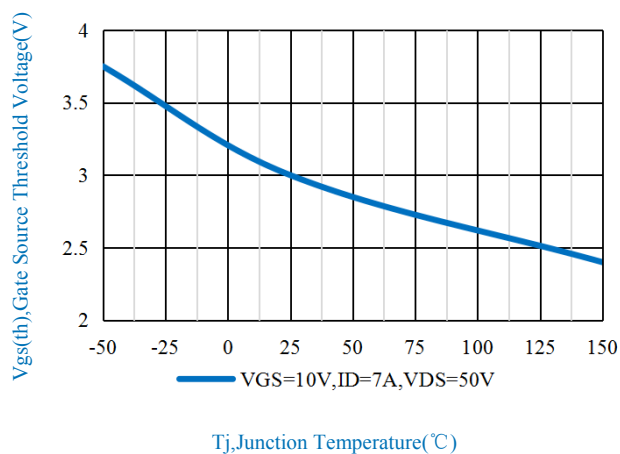


Fig.11-Gate Source Threshold Voltage Vs. Junction Temperature

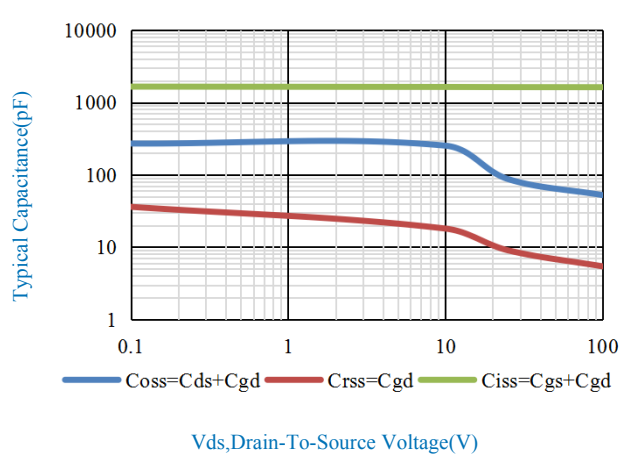


Fig.12-Typical Capacitance Vs. Drain-To-Source Voltage

NPS7N80D

N-Channel Enhancement Mode Power MOSFET



Typical Characteristics Curves

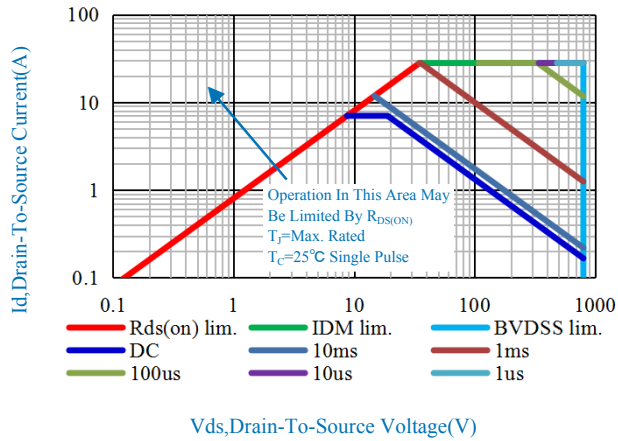


Fig.13-Maximum Safe Operating Area(SOA)

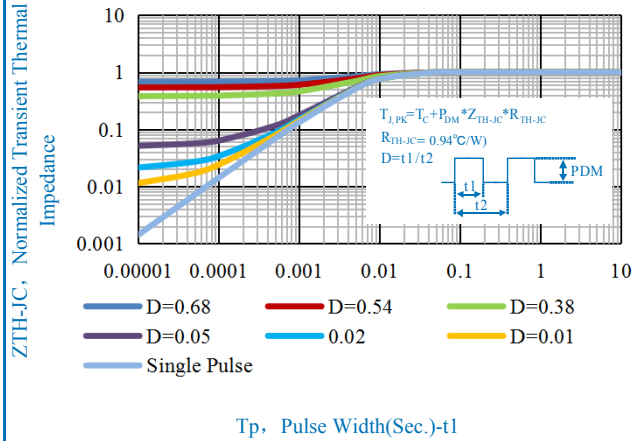


Fig.14- Normalized Maximum Transient Thermal Impedance Vs. Pulse Width

Test Circuit & Waveform

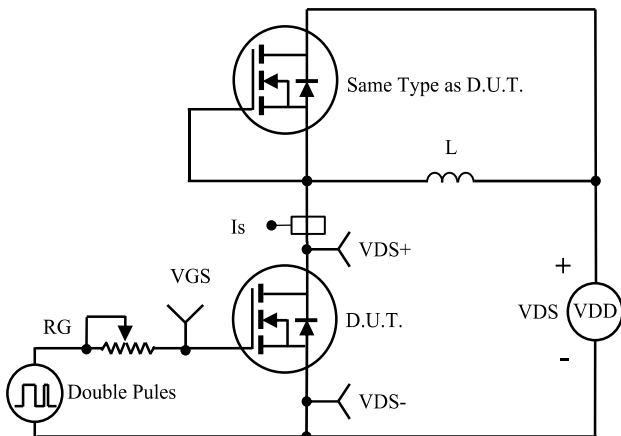


Fig.15- Inductive Switching Test Circuit & Waveform

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

Test Circuit & Waveform

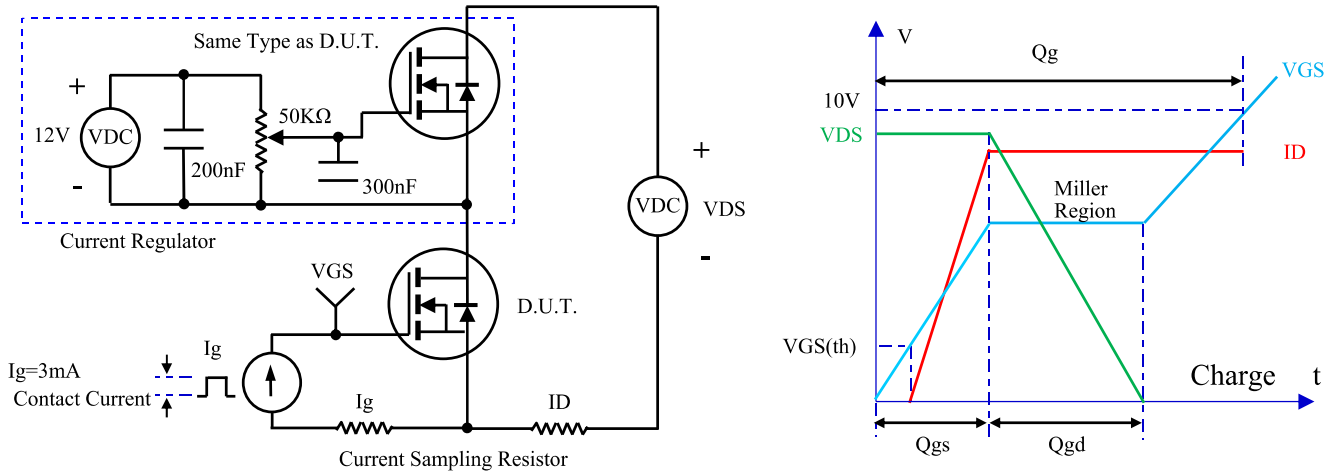


Fig.16-Gate Charge Test Circuit & Waveform

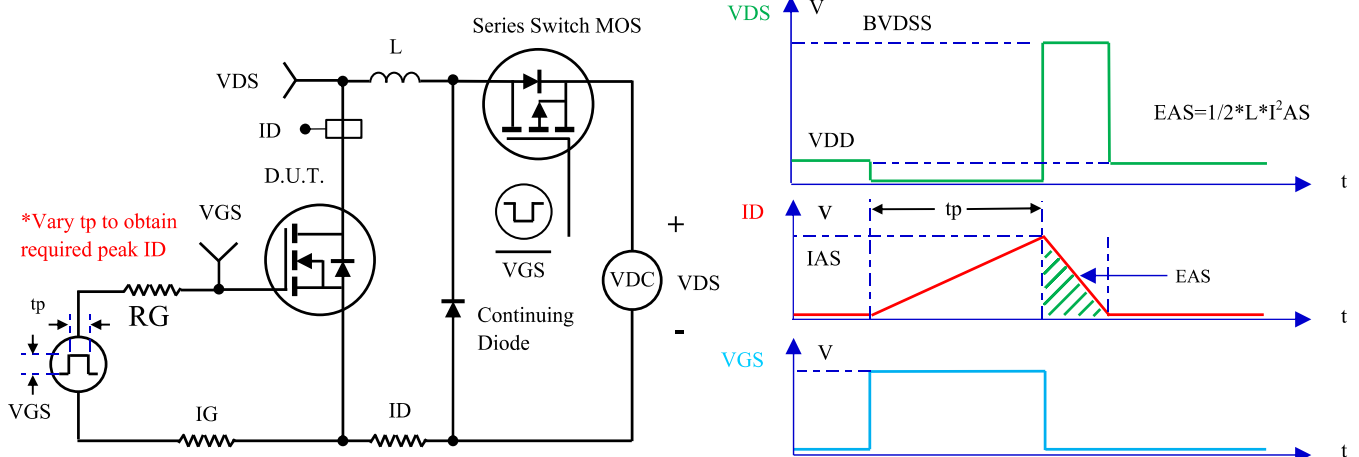


Fig.17- Unclamped Inductive Switching (UIS) Test Circuit & Waveform

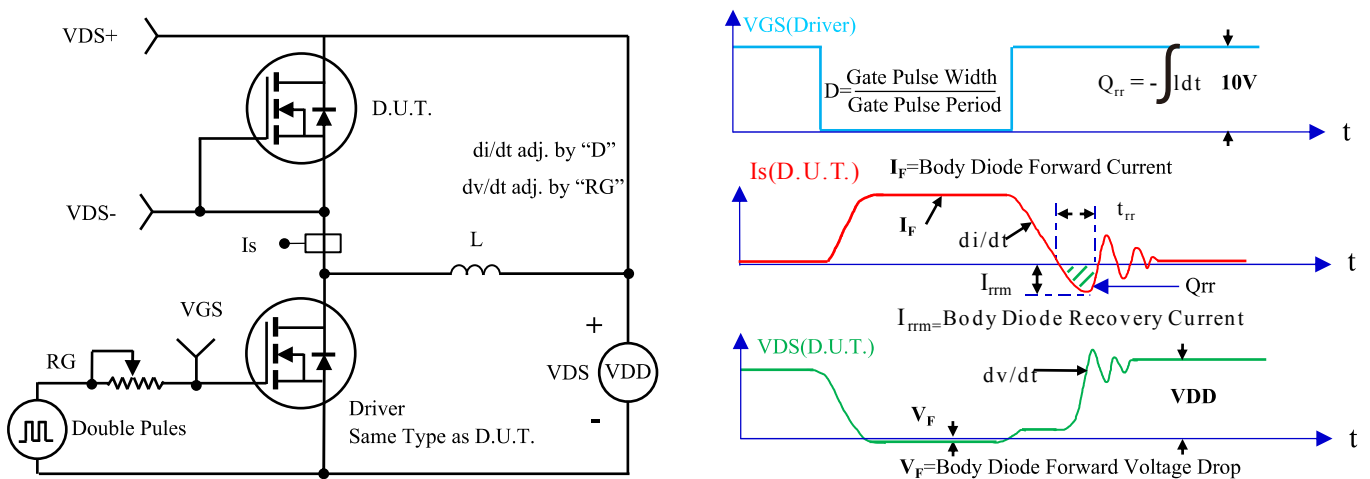


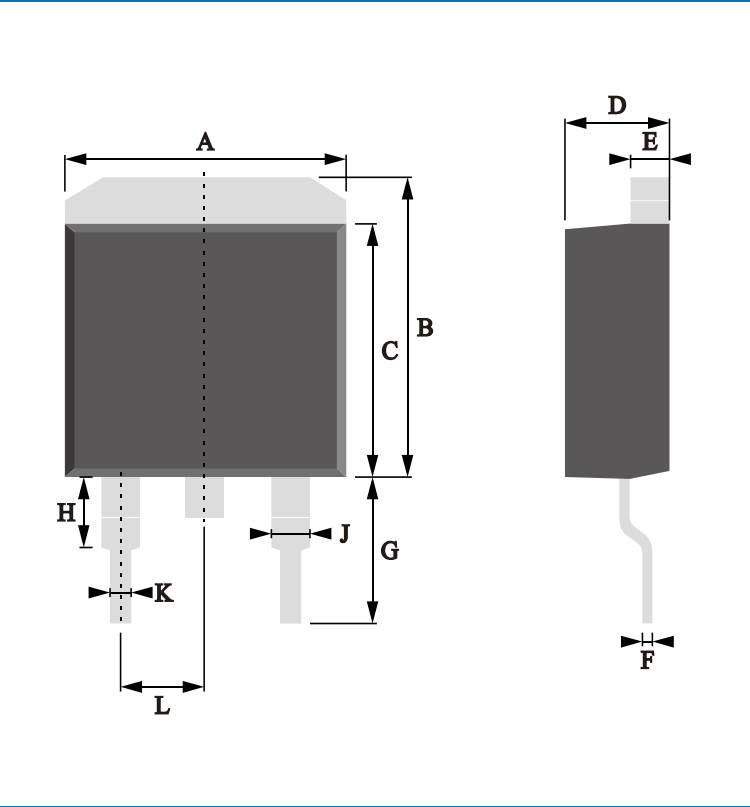
Fig.18- Diode Recovery Test Circuit & Waveform

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

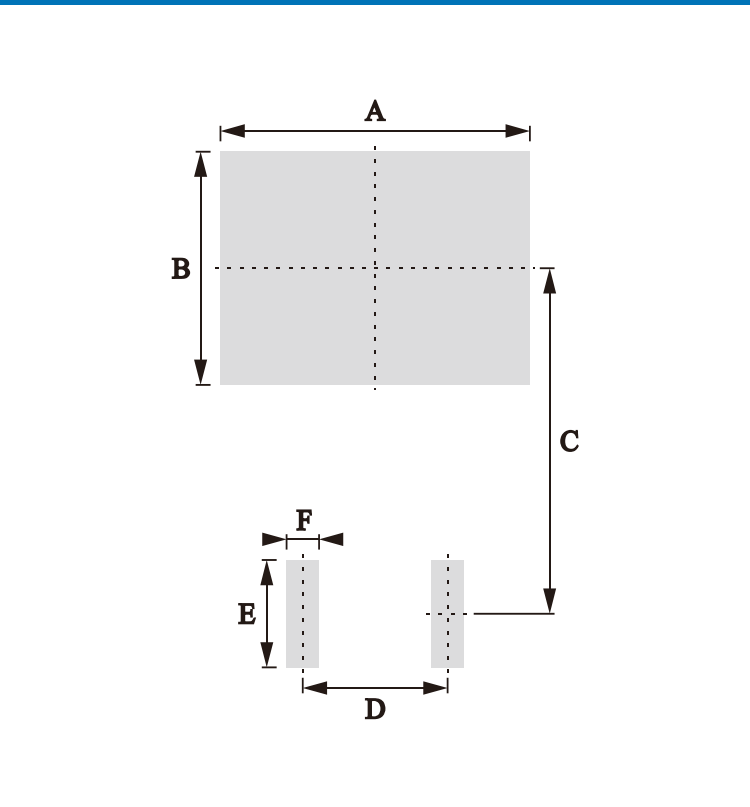
OUTLINE DRAWINGS



TO-263

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.30	-	10.50	0.3661	-	0.4134
B	9.60	-	11.60	0.3780	-	0.4567
C	8.20	-	9.50	0.3228	-	0.3740
D	4.00	-	5.00	0.1575	-	0.1969
E	1.00	-	1.70	0.0394	-	0.0669
F	0.20	-	0.70	0.0079	-	0.0276
G	4.45	-	5.25	0.1752	-	0.2067
H	1.25	-	1.85	0.0492	-	0.0728
J	1.00	-	1.60	0.0394	-	0.0630
K	0.60	-	1.00	0.0236	-	0.0394
L	2.25	-	2.80	0.0886	-	0.1102

RECOMMEDND LAYOUT DRAWINGS



TO-263

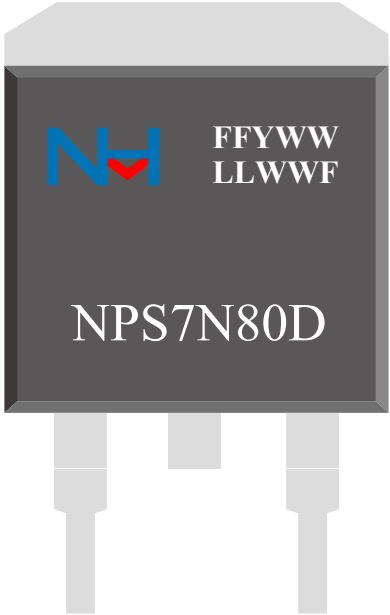
OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	10.86	-	-	0.4276	-
B	-	7.86	-	-	0.3094	-
C	-	11.64	-	-	0.4583	-
D	-	5.08	-	-	0.2000	-
E	-	3.62	-	-	0.1425	-
F	-	1.14	-	-	0.0449	-

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

MARKING INFORMATION



MARKING INSTRUCTIONS

NH=Niuhang Trademark
FF=Product Line Code,According To Actual Changes
YWW=Date Code,According To Actual Changes
LLWWF=Inernal Code,According To Actual Changes
NPS7N80D=Model

PACKING INFORMATION

Package Type	Package Code	Product Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
TO-263	P1	1.4331	13" Reel	800	800	4000
TO-263	P2	1.4331	13" Reel	800	800	4800

NPS7N80D



N-Channel Enhancement Mode Power MOSFET

Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow

	Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
	Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
	Preheat-Temperature Min (T _S min) -Temperature Max (T _S max) -Time(t _s min to t _s max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
	Time maintained above: -Temperature (T _L) - Time (t _L)	183°C 60-150 seconds	217°C 60-150 seconds
	Peak Temperature(T _P)	240 +0/-5 °C	260 +0/-5 °C
	Time within 5°C of actual peak temperature (t _p)	10-30 seconds	20-40 seconds
	Ramp down rate	6°C/second max.	6°C/second max.
	Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

Disclaimer

- Reproducing and modifying information of the document is prohibited without permission from Niuhang Electronics Technology Co., LTD
- Niuhang Electronics Technology Co., LTD. reserves the rights to make changes of the content herein the document anytime without notification.
- Niuhang Electronics Technology Co., LTD. disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially occurred.
- Niuhang Electronics Technology Co., LTD. does not assume any and all implied warranties,including warranties of fitness for particular purpose,non-infringement and merchantability.
- Applications shown on the herein document are examples of standard use and operation.Customers are responsible in comprehending the suitable use in particular applications.Niuhang Electronics Technology Co., LTD.makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.
- The products shown herein are not designed and authorized for equipments requiring high level of reliability or relating to human life and for any applications concerning life-saving or life-sustaining,such as medical instruments,transportation equipment,aerospae machinery et cetera.Customers usin or selling these products for use in such applications do so at their own rish and agree to fully indemnify Niuhang Electronics Technology Co., LTD.for any damages resulting resulting from such improper use or sale.
- When the appearance of the product and chip size does not change, in order to product the customer. quality, change the internal structure and the production process Niuhang can not notify

NPS7N80D

N-Channel Enhancement Mode Power MOSFET



Specification Revision History

Rev.	Date	Changed Items	Pre-Changed Content	Changed Content
A/1	2014-10-20	First Issue		
Blank Below				